Wide-Input Sensorless CC/CV Step-Down DC/DC Converter www.siliconpower.cn 产品资料/样品申请



#### **FEATURES**

- 40V Input Voltage Surge
- 38V Steady State Operation
- Up to 3A output current
- Output Voltage up to 12V
- Patent Pending Active CC Sensorless Constant Current Control
- Integrated Current Control Improves
   Efficiency, Lowers Cost, and Reduces
   Component Count
- Resistor Programmable
- Current Limit from 1.5A to 3A
- Patented Cable Compensation from  $0\Omega$  to  $0.3\Omega$
- ±7.5% CC Accuracy
- Compensation of Input /Output Voltage Change
- Temperature Compensation
- Independent of inductance and Inductor DCR
- 2% Feedback Voltage Accuracy
- Up to 94% Efficiency
- 125kHz Switching Frequency Eases EMI Design
- Advanced Feature Set
- Integrated Soft Start
- Thermal Shutdown
- Secondary Cycle-by-Cycle Current Limit
- Protection Against Shorted ISET Pin
- ESOP-8L Package

#### **APPLICATIONS**

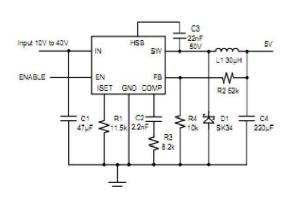
- · Car Charger/ Adaptor
- · Battery Charger
- · Rechargeable Portable Devices
- USB Power Supplies
- General-Purpose CC/CV Supply

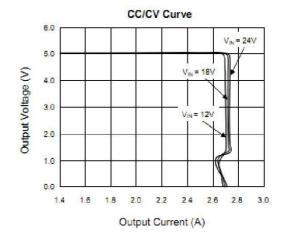
#### **GENERAL DESCRIPTION**

SP4533 is a wide input voltage, high efficiency CC step-down DC/DC converter that operates in either CV (Constant Output Voltage) mode or CC (Constant Output Current) mode. SP4533 provides up to 3A output current at 125kHz switching frequency.

Active CC is a patent-pending control scheme to achieve highest accuracy sensorless constant current control. Active CC eliminates the expensive, high accuracy current sense resistor making it ideal for battery charging applications and adaptors with accurate current limit. The SP4533 achieves higher efficiency than traditional constant current switching regulators by eliminating its associated power loss

Protection features include cycle-by-cycle current limit, thermal shutdown, and frequency foldback at short circuit. The devices are available in a ESOP-8L package and require very few external devices for operation





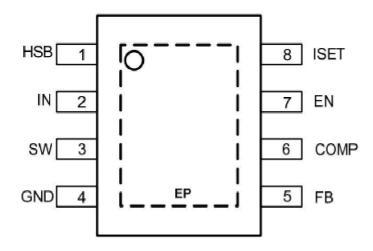
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## **ORDERING INFORMATION**

PART NUMBER	PERATION TEMPERATURE RANG	PACKAGE	PACKING
SP4533	-40°to 85°C	ESOP-8L	TAPE & REEL

## **PIN CONFIGURATION**



**ESOP-8L** 

### **PIN DESCRIPTIONS**

	Lockii II	
PIN	NAME	DESCRIPTION
		High Side Bias Pin. This provides power to the internal high-side MOSFET gate
1	HSB	driver Connect a 22nF capacitor from HSB pin to SW pin
		Power Supply Input. Bypass this pin with a 10µF ceramic capacitor to GND, placed as
2	IN	close to the IC as possible
3	SW	Power Switching Output to External Inductor
4	GND	Ground. Connect this pin to a large PCB copper area for best heat dissipation. Return
4	GND	FB, COMP, and ISET to this GND, and connect this GND to power GND at a single
5	FB	Feedback Input. The voltage at this pin is regulated to 0.808V. Connect to the resistor
J	ГБ	divider between output and GND to set the output voltage
6	COMP	Error Amplifier Output. This pin is used to compensate the converter.
		Enable Input. EN is pulled up to 5V with a 4µA current, and contains a precise 1.6V
7	EN	logic threshold. Drive this pin to a logic-high or leave unconnected to enable the IC.
		Drive to a logic-low to disable the IC and enter shutdown mode
8	ISET	Output Current Setting Pin. Connect a resistor from ISET to GND to program the
0	1051	output current.
	Exposed	Heat Dissipation Pad. Connect this exposed pad to large ground copper area with
	Pad	copper and vias

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## **ABSOLUTE MAXIMUM RATINGS**

PARAMETER	VALUE	UNIT
IN to GND	-0.3 to 40	V
SW to GND	-1 to VIN + 1	V
HSB to GND	VSW - 0.3 to VSW + 7	V
FB, EN, ISET, COMP to GND	-0.3 to + 6	V
Junction to Ambient Thermal Resistance	46	°C/W
Operating Junction Temperature	-40 to 150	$^{\circ}$ C
Storage Junction Temperature	-55 to 150	$^{\circ}$
ESD susceptibility HBM(Human Body Model)	3000	V

Do not exceed these limits to prevent damage to the device Exposure to absolute maximum rating conditions for long periods may affect device reliability.

# **Recommended Operating Conditions**

PARAMETER	VALUE	UNIT
Supply Input Voltage	10 to 38	V
Ambient Temperature Range	-20 to 85	${\mathbb C}$
Junction Temperature Range	-40 to 125	${\mathbb C}$

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### **ELECTRICAL CHARACTERISTICS**

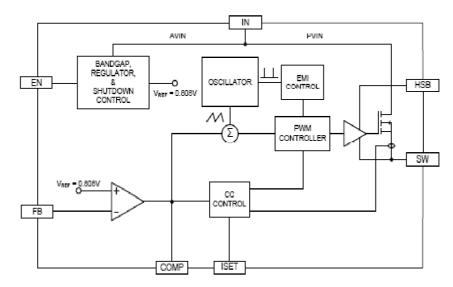
(VIN = 20V, TA = 25°C, unless otherwise specified.)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Input Voltage		10		38	V
Input Voltage Surge				40	V
VIN UVLO Turn-On Voltage	Input Voltage Rising	9.0	9.4	9.7	V
VIN UVLO Hysteresis	Input Voltage Falling		1.1		V
Standby Supply Current	VEN = 3V, VFB = 1V		0.9		mA
Standby Supply Current	VEN = 3V VOUT = 5V No		3		mA
Shutdown Supply Current	VEN = 0V		75		μΑ
Feedback Voltage			808		mV
Internal Soft-Start Time			400		μs
Error Amplifier Transcenductones	VFB = VCOMP = $0.8V$ , $\Delta$		650		µA/V
Error Amplifier Transconductance	ICOMP = ± 10µA		650		μΑνν
Error Amplifier DC Gain			4000		V/V
Switching Frequency	VFB = 0.808V		125		kHz
Foldback Switching Frequency	VFB = 0V		20		kHz
Maximum Duty Cycle			88		%
Minimum On-Time			200		ns
COMP to Current Limit Transconductan	VCOMP = 1.2V		5.25		A/V
Secondary Cycle-by-Cycle Current Lim	Duty Cycle = 0%		4.5		A
Slope Compensation	Duty = DMAX		1.2		A
ISET Voltage			1		V
ISET to IOUT DC Room Temp Current	IOUT / ISET, RISET = 19.		25000		A/A
CC Controller DC Accuracy	RISET = $19.6k\Omega$ , VOUT = $3.5V$ , Open-Loop DC		1190		Ма
EN Threshold Voltage	EN Pin Rising		1.6		V
EN Hysteresis	EN Pin Falling		125		mV
EN Internal Pull-up Current			4		μΑ
High-Side Switch ON-Resistance			0.16		Ω
SW Off Leakage Current	VEN = VSW = 0V		1		μΑ
Thermal Shutdown Temperature	Temperature Rising		150		${\mathbb C}$
Thermal Shutdown Temperature Hyster	Temperature Falling		20		${\mathbb C}$

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#### **FUNCTIONAL BLOCK DIAGRAM**



# FUNCTIONAL DESCRIPTION CV/CC Loop Regulation

As seen in Functional Block Diagram, the SP4533 is a peak current mode pulse width modulation (PWM) converter with CC and CV control. The converter operates as follows:

A switching cycle starts when the rising edge of the Oscillator clock output causes the High-Side Power Switch to turn on and the Low-Side Power Switch to turn off With the SW side of the inductor now connected to IN, the inductor current ramps up to store energy in the magnetic field. The inductor current level is measured by the Current Sense Amplifier and added to the Oscillator ramp signal. If the resulting summation is higher than the COMP voltage the output of the PWM Comparator goes high. When this happens or when Oscillator clock output goes low, the High-Side Power Switch turns off.

At this point, the SW side of the inductor swings to a diode voltage below ground causing the inductor current to decrease and transferred to output. This state continues until themagnetic energy to be cycle starts again. The High-Side Power Switch is driven by logic using HSB as the positive rail This pin is charged to VSW + 5V when the Low-Side Power Switch turns on. The COMP voltage is the integration of the error between FB input and the internal 0.808V reference. If FB is lower than the reference voltage, COMP tends to go higher to increase current to the output Output current will increase until it reaches the CC limit set by the ISET resistor. At this point, the device will transition from

regulating output voltage to regulating output current and the output voltage will drop with increasing load.

The Oscillator normally Switched at 125kHz However if FB voltage is less than 0 6V then the switching frequency decreases until it reaches a typical value of 20kHz at VFB = 0.15V.

#### **Enable Pin**

The SP4533 has an enable input EN for turning the IC on or off. The EN pin contains a precision 1.6V comparator with 125mV hysteresis and a 4 $\mu$ A pullup current source. The comparator can be used with a resistor divider from VIN to program a startup voltage higher than the normal UVLO value. It can be used with a resistor divider from VOUT to disable charging of a deeply discharged battery, or it can be used with a resistor divider containing a thermistor to provide a temperature-dependent shutoff protection for over temperature battery. The thermistor should be thermally coupled to the battery pack for this usage.

If left floating, the EN pin will be pulled up to roughly 5V by the internal 4  $\mu$  A current source. It can be driven from standard logic signals greater than 1.6V, or driven with open-drain logic to provide digital on/off control.

#### **Thermal Shutdown**

The SP4533 disables switching when its junction temperature exceeds 150°C and resumes when the temperature has dropped by 20°C.



#### **APPLICATIONS INFORMATION**

#### **Output Voltage Setting**

Figure 1:

**Output Voltage Setting** 

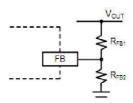


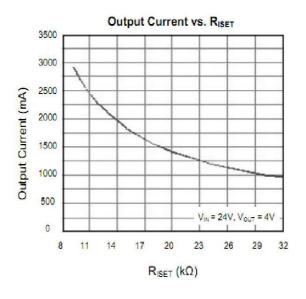
Figure 1 shows the connections for setting the output voltage. Select the proper ratio of the two feedback resistors RFB1 and RFB2 based on the output voltage. Typically, use RFB2  $\approx$  10k $\Omega$  and determine RFB1 from the following equation:

$$R_{FB1} = R_{FB2} \left( \frac{V_{OUT}}{0.808V} - 1 \right) \tag{1}$$

#### **CC Current Setting**

SP4533 constant current value is set by a resistor connected between the ISET pin and GND. The CC connected between the ISET pin and GND. The CC output current is linearly proportional to the current flowing out of the ISET pin. The voltage at ISET is roughly 1V and the current gain from ISET to output is roughly 25000 (25mA/1  $\mu$  A). To determine the proper resistor for a desired current, please refer to Figure 2 below.

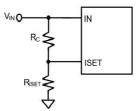
Figure 2: Curve for Programming Output CC Current



#### **CC Current Line Compensation**

When operating at constant current mode, the current limit increase slightly with input voltage. For wide input voltage applications, a resistor RC is added to compensate line change and keep output high CC accuracy as shown in Figure 3

Figure 3: lutput Line Compensation



#### **Inductor Selection**

The inductor maintains a continuous current to the output load. This inductor current has a ripple that is dependent on the inductance value:

Higher inductance reduces the peak-to-peak ripple current. The trade off for high inductance value is the increase in inductor core size and series resistance, and the reduction in current handling capability. In general, select an inductance value L based on ripple current requirement:

$$L = \frac{V_{\text{OUT}} \times (V_{\text{IN}} - V_{\text{OUT}})}{V_{\text{IN}} f_{\text{SW}} I_{\text{OADMAX}} K_{\text{RIPPLE}}}$$
(2)

where VIN is the input voltage, VOUT is the output voltage, fSW is the switching frequency, ILOADMAX is the maximum load current, and KRIPPLE is the ripple factor. Typically, choose KRIPPLE = 30% to correspond to the peak-to-peak ripple current being 30% of the maximum load current.

With a selected inductor value the peak-to-peak inductor current is estimated as:

$$I_{LPK-PK} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{L \times V_{IN} \times f_{SW}}$$
(3)

The peak inductor current is estimated as:

$$I_{LPK} = I_{LOADMAX} + \frac{1}{2}I_{LPK-PK} \tag{4}$$

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#### **APPLICATIONS INFORMATION**

The selected inductor should not saturate at ILPK The maximum output current is calculated

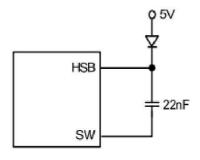
$$I_{OUTMAX} = I_{LIM} - \frac{1}{2}I_{LPK-PK}$$
(5)

LLIM is the internal current limit which is typically 3.2A, as shown in Electrical Characteristics

#### External High Voltage Bias Diode

It is recommended that an external High Voltage Bias diode be added when the system has a 5V fixed input or the power supply generates a 5V output. This helps improve the efficiency of the regulator The High Voltage Bias diode can be a low cost one such as IN4148 or BAT54.

Figure 4: External High Voltage Bias Diode



This diode is also recommended for high duty cycle operation and high output voltage

#### **Input Capacitor**

The input capacitor needs to be carefully selected to maintain sufficiently low ripple at the supply input of the converter. A low ESR capacitor is highly recommended. Since large current flows in and out of this capacitor during switching, its ESR also affects efficiency.

The input capacitance needs to be higher than 10  $\mu\text{F}.$  The best choice is the ceramic type,however, low ESR tantalum or electrolytic types may also be used provided that the RMS ripple current rating is higher than 50% of the output current.

The input capacitor should be placed close to the IN and G pins of the IC, with the shortest traces possible. In the case of tantalum or electrolytic types, they can be further away if a small parallel 0.1µF ceramic capacitor is placed right next to the IC.

#### **Output Capacitor**

The output capacitor also needs to have low ESR to keep low output voltage ripple. The output ripple voltage is:

$$V_{RIPPLE} = I_{OUTMAX} K_{RIPPLE} R_{ESR} + \frac{V_{IN}}{28 \times f_{SW}^2 LC_{OUT}}$$
 (6)

KRIPPLE is the ripple factor, RESR is the ESR of the output capacitor, fSW is the switching frequency, L is the inductor value, and COUT is the output capacitance. In the case of ceramic output capacitors, RESR is very small and does not contribute to the ripple. Therefore, a lower capacitance value can be used for ceramic type In the case of tantalum or electrolytic capacitors, the ripple is dominated by RESR multiplied by the ripple current. In that case, the output capacitor is chosen to have sufficiently low ESR.

For ceramic output capacitor, typically choose a capacitance of about 22  $\mu$  F. For tantalum or electrolytic capacitors, choose a capacitor with less than 50m $\Omega$  ESR.

#### **Rectifier Diode**

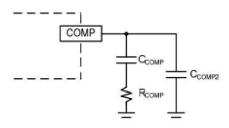
Use a Schottky diode as the rectifier to conduct current when the High-Side Power Switch is off. The Schottky diode must have current rating higher than the maximum output current and a reverse voltage rating higher than the maximum input voltage.

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#### STABILITY COMPENSATION

## Figure 5: **Stability Compensation**



1: CCOMP2 is needed only for high ESR output capacitor

The feedback loop of the IC is stabilized by the components at the COMP pin, as shown in Figure 5. The DC loop gain of the system is determined by the following equation:

$$A_{VDC} = \frac{0.808 \text{ V}}{I_{OUT}} A_{VEA} G_{COMP}$$
 (7)

The dominant pole P1 is due to CCOMP:

$$f_{P1} = \frac{G_{EA}}{2 \pi A_{VEA} C_{COMP}}$$
 (8)

The second pole P2 is the output pole:

$$f_{\rm P2} = \frac{I_{\rm OUT}}{2\pi V_{\rm OUT}\,C_{\rm OUT}} \tag{9}$$
 The first zero Z1 is due to RCOMP and CCOMP:

$$f_{z_1} = \frac{1}{2\pi R_{COUR} C_{COUR}} \tag{10}$$

And finally, the third pole is due to RCOMP and CCOMP2 (if CCOMP2 is used):

$$f_{P3} = \frac{1}{2\pi R_{COMP}C_{COMP2}}$$
(11)

The following steps should be used to compensate the IC:

STEP 1. Set the cross over frequency at 1/10 of the switching frequency via RCOMP:

$$R_{comP} = \frac{2\pi V_{out} C_{out} f_{sw}}{10 G_{EA} G_{comP} \times 0.808 V}$$
  
= 5.12 × 10<sup>7</sup>  $V_{out} C_{out}$  (Ω) (12)

STEP 2. Set the zero fZ1 at 1/4 of the cross over frequency. If RCOMP is less than  $15k\Omega$ , the equation for CCOMP is:

$$C_{\text{comp}} = \frac{2.83 \times 10^{-6}}{R_{\text{comp}}} \qquad (F) \tag{13}$$

If RCOMP is limited to  $15k\Omega$ , then the actual cross over frequency is 6.58 / (VOUTCOUT). Therefore:

$$C_{COMP} = 6.45 \times 10^{-6} V_{OUT} C_{OUT}$$
 (F) (14)

STEP 3. If the output capacitor 's ESR is high enough to cause a zero at lower than 4 times the cross over frequency, an additional compensation capacitor CCOMP2 is required. The condition for using CCOMP2 is:

$$R_{\text{ESRCOUT}} \ge \left(Min \frac{1.77 \times 10^{-6}}{C_{\text{OUT}}}, 0.006 \times V_{\text{OUT}}\right) (\Omega)$$
 (15)

And the proper value for CCOMP2 is:

$$C_{comp 2} = \frac{C_{out} R_{Esrcout}}{R_{comp}}$$
 (16)

Though CCOMP2 is unnecessary when the output capacitor has sufficiently low ESR, a small value CCOMP2 such as 100pF may improve stability against PCB layout parasitic effects.

Table 1 shows some calculated results based on the compensation method above

Table 1: **Typical Compensation for Different Output Voltages and Output Capacitors** 

$V_{\text{OUT}}$	Соит	R <sub>COMP</sub>	Ссоме	C <sub>COMP2</sub> ©
2.5V	47μF Ceramic CAP	5.6kΩ	3.3nF	None
3.3V	47μF Ceramic CAP	6.2kΩ	3.3nF	None
5V	47μF Ceramic CAP	8.2kΩ	3.3nF	None
2.5V	470μF/6.3V/30mΩ	39kΩ	22nF	47pF
3.3V	470μF/6.3V/30mΩ	45kΩ	22nF	47pF
5V	470μF/6.3V/30mΩ	51kΩ	22nF	47pF

CCOMP2 is needed for high ESR output capacitor.

 $CCOMP2 \leq 47pF$  is recommended.

#### CC Loop Stability

The constant-current control loop is internally compensated over the 1500mA-3000mA output range. No additional external compensation is required to stabilize the CC current.

#### **Output Cable Resistance Compensation**

To compensate for resistive voltage drop across the charger's output cable, the SP4533 integrates a simple, user-programmable cable voltage drop compensation using the impedance at the FB pin.Use the curve in Figure 6 to choose the proper feedback resistance values for cable compensation.



#### STABILITY COMPENSATION CONT'D

In the case of high RFB1 used, the frequency compensation needs to be adjusted correspondingly As show in Figure 7 adding a capacitor in paralled with RFB1 or increasing the compensation capacitance at COMP pin helps the system stability.

## Figure 6:

Cable Compensation at Various Resistor Divider Values

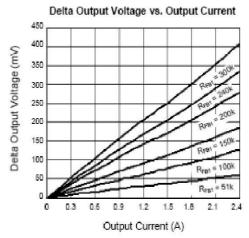
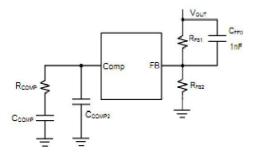


Figure 7: Frequency Compensation for High RFB1



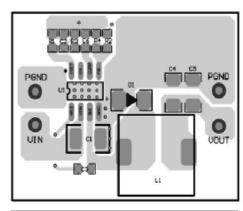
#### **PC Board Layout Guidance**

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the IC.

- 1) Arrange the power components to reduce the AC loop size consisting of CIN, IN pin, SW pin and the schottky diode.
- 2) Place input decoupling ceramic capacitor CIN as close to IN pin as possible. CIN is connected power GND with vias or short and wide path.
- 3) Return FB COMP and ISET to signal GND pin,and connect the signal GND to power GND at a single point for best noise immunity. Connect exposed pad to power ground copper area with copper and vias.

- 4) Use copper plane for power GND for best heat dissipation and noise immunity.
- 5) Place feedback resistor close to FB pin.
- 6) Use short trace connecting HSB-CHSB-SW loop

Figure 8 shows an example of PCB layout.



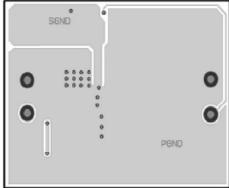


Figure 8: PCB Layout

Figure 9 gives one typical car charger application schematic and associated BOM list.



Figure 9: Typical Application Circuit for 5V/2.4A Car Charger

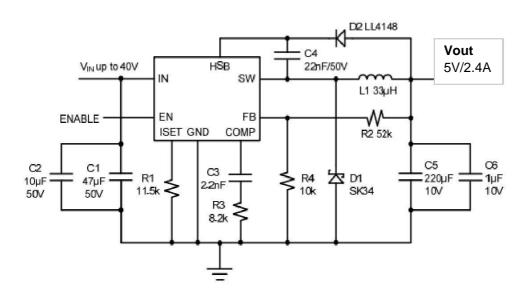


Table 2: BOM List for 5V/2.4A Car Charger

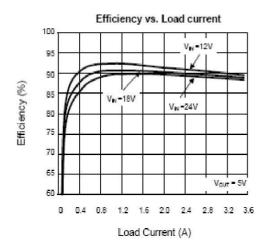
ITEM	REFERENCE	DESCRIPTION	MANUFACTURER	QTY
1	U1	IC, SP4533, ESOP-8L	Siliconpower	1
2	C1	Capacitor, Electrolytic, 47µF/50V, 6.3x7mm	Murata, TDK	1
3	C2	Capacitor Ceramic 10µF/50V 1206 SMD	Murata TDK	1
4	C3	Capacitor, Ceramic, 2.2nF/6.3V, 0603, SMD	Murata, TDK	1
5	C4	Capacitor, Ceramic, 22nF/50V, 1206, SMD	Murata, TDK	1
6	C5	Capacitor, Electrolytic, 220µF/10V, 6.3x7mm	Murata, TDK	1
7	C6	Capacitor, Ceramic, 1µF/10V, 0603, SMD	Murata, TDK	1
8	L1	Inductor,33µH, 3A, 20%, SMD	Tyco Electronics	1
9	D1	Diode, Schottky, 40V/3A, SK34	Diodes	1
10	D2	Diode 75V/150mA LL4148	Good-ARK	1
11	R1	Chip Resistor, 11.5kΩ, 0603, 1%	Murata, TDK	1
12	R2	Chip Resistor, 52kΩ, 0603, 1%	Murata, TDK	1
13	R3	Chip Resistor, 8.2kΩ, 0603, 5%	Murata, TDK	1
14	R4	Chip Resistor, 10kΩ, 0603, 1%	Murata, TDK	1

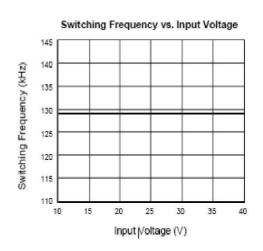
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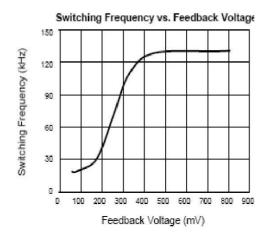


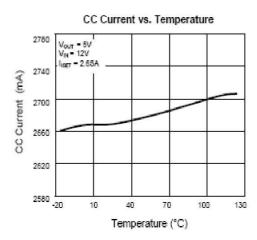
#### TYPICAL PERFORMANCE CHARACTERISTICS

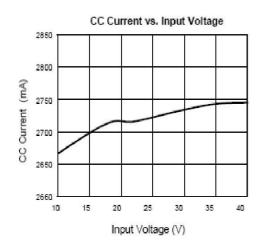
(L = 33μH, CIN = 10μF, COUT = 47μF, Ta = 25°C, RCOMP = 8.2k, CCOMP1 = 2.2nF, CCOMP2 = NC)

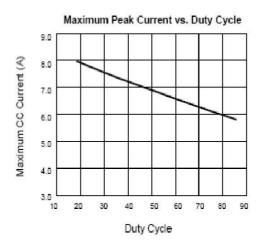








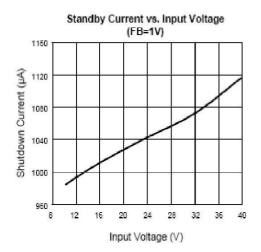


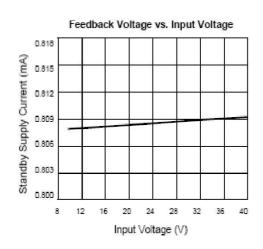


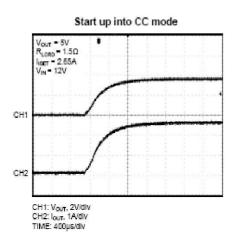
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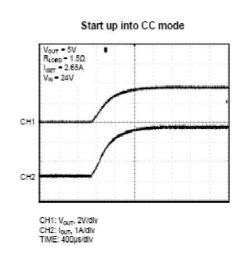


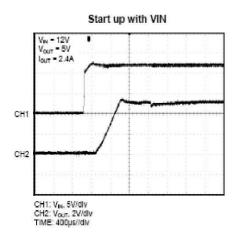
### TYPICAL PERFORMANCE CHARACTERISTICS CONT'D

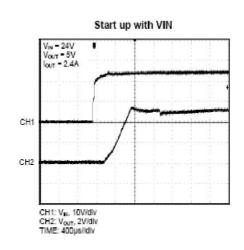






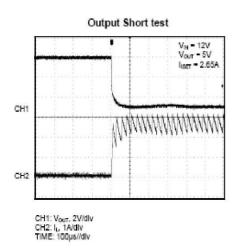


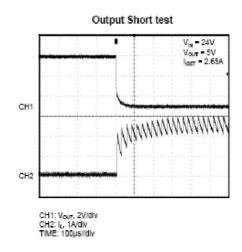


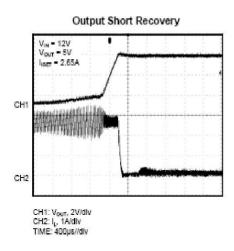


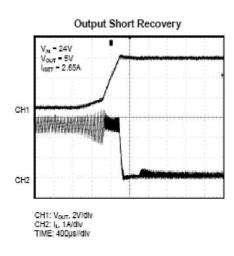


#### TYPICAL PERFORMANCE CHARACTERISTICS CONT'D





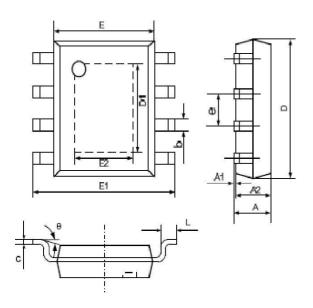




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# PACKAGE OUTLINE ESOP-8L PACKAGE OUTLINE AND DIMENSIONS



SYMBOL		SION IN IETERS	DIMENSION IN INCHES	
9	MIN	MAX	MIN	MAX
Α	1.350	1.700	0.053	0.067
A1	0.000	0.100	0.000	0.004
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
С	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.200
D1	3.202	3.402	0.126	0.134
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
E2	2.313	2.513	0.091	0.099
е	1.270 TYP		0.050 TYP	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

#### Note

- 1. Dimension D does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15mm per end.
- 2. Dimension E does not include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25mm per side.